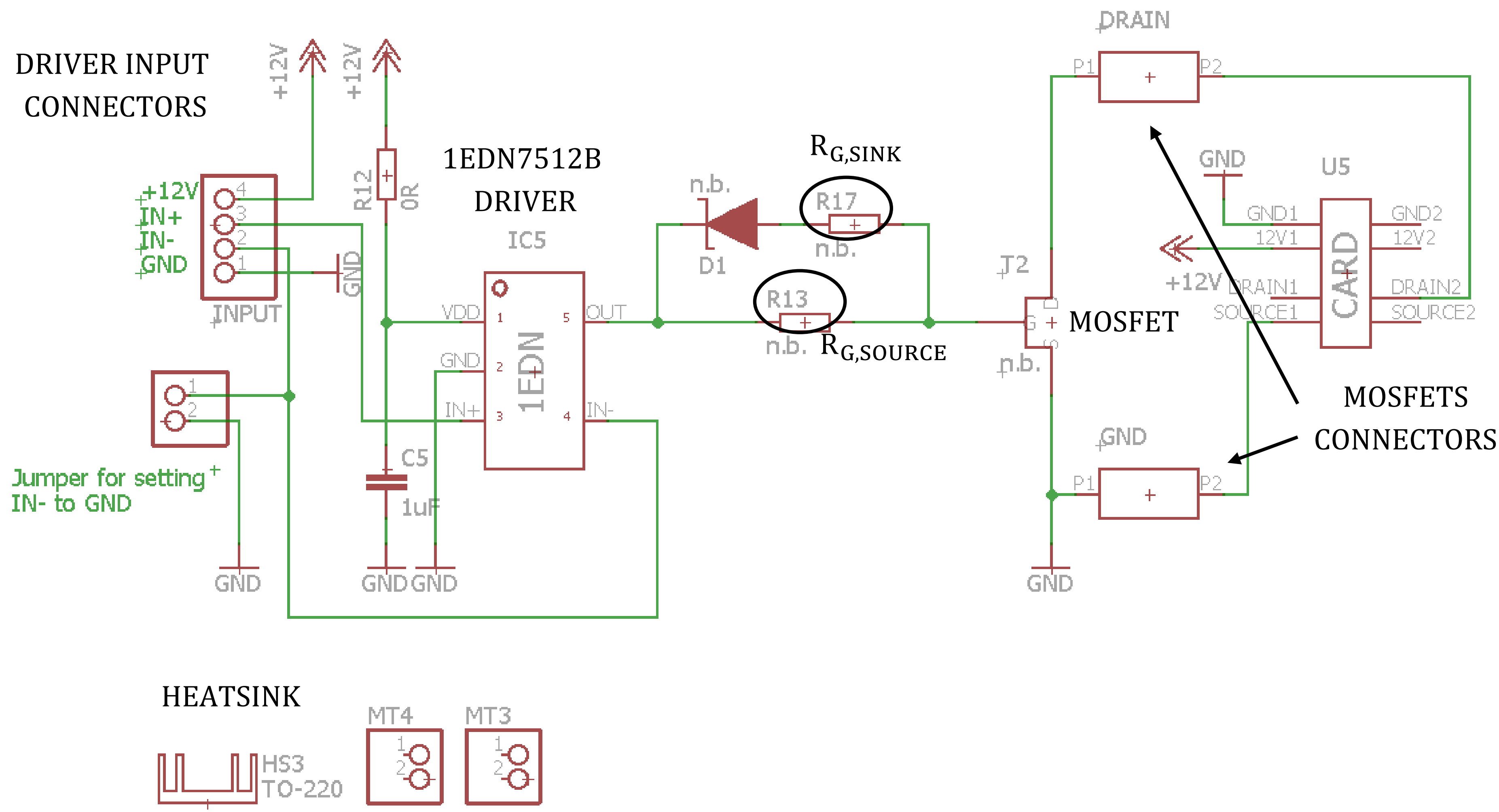
Quick start guide
KIT_DRIVER_1EDN7512B

Infineon Technologies

KIT_DRIVER_1EDN7512B

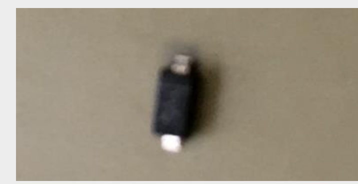
Included in this kit

Board schematic



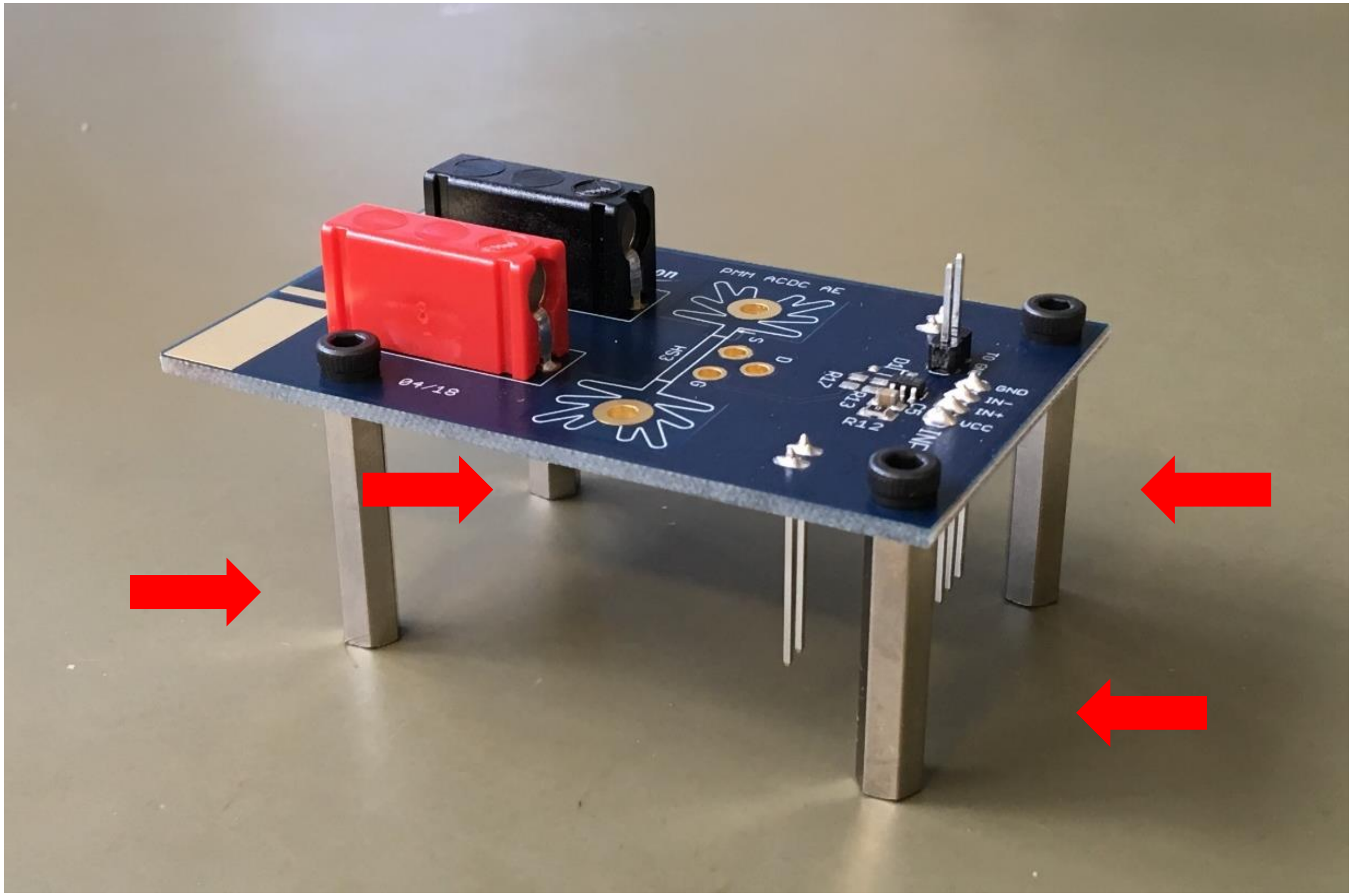
Components to add – BOM suggestion

Distance bolts	Screws for distance bolts	Screw and washer for MOSFET mounting to heatsink	TO-220 sockets
			

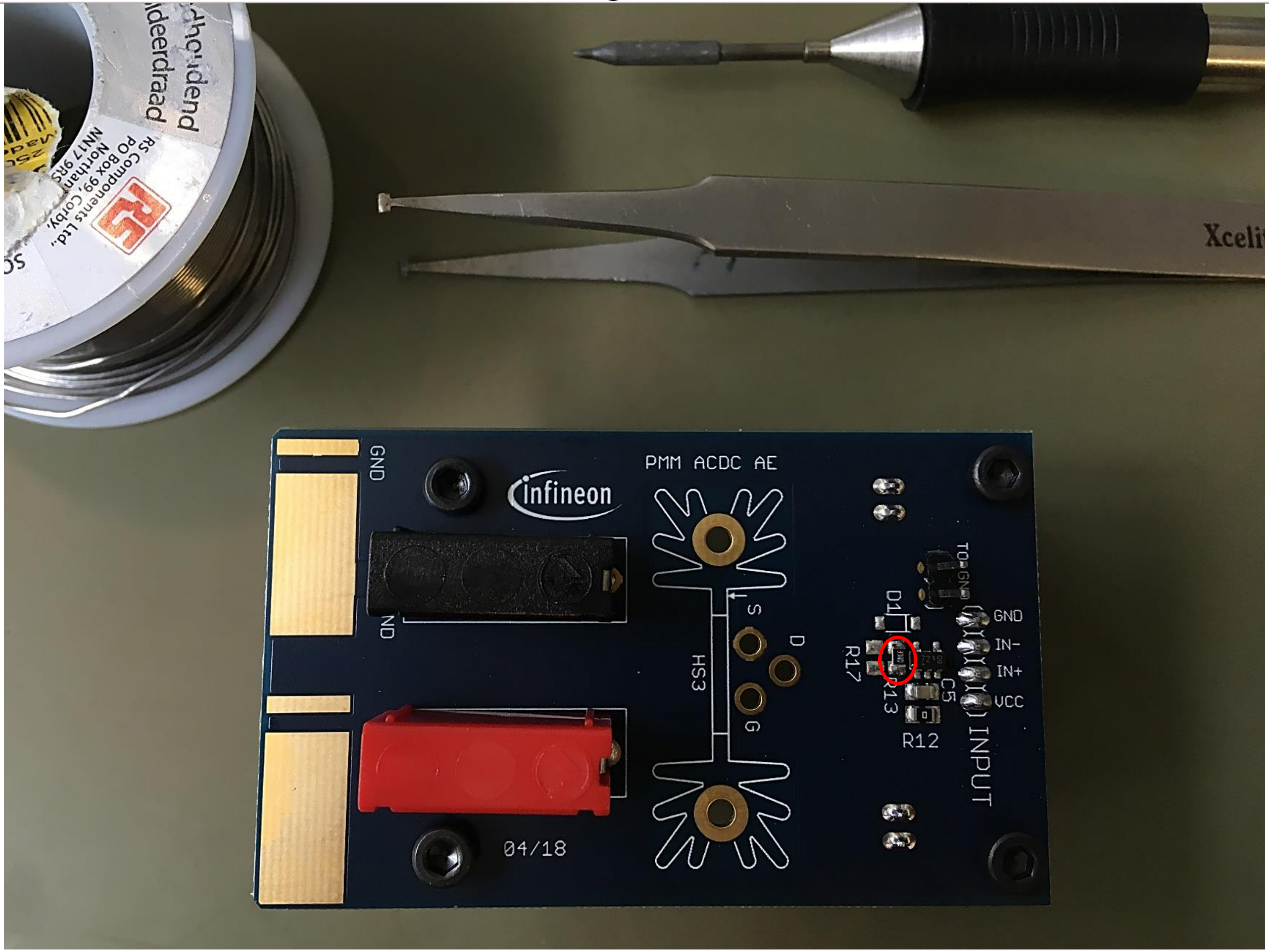
TO-220 MOSFET	Source resistor (R13)	Sink resistor (R17)	
			

Component	Quantity	Designator	Comment	Voltage	Footprint	Type	Part number/ supplies
Resistors	2	R13,R17			RES805R	SMD ceramic resistor	
Sink diode	1	D1	Schottky diode	30V	SOD-123	PMEG3020 Schottky diode	816-6858 RS-Components
TO-220 sockets	1	T2	TO-220 socket		TO-220	Receptacle Connector 0.034" ~ 0.041" (0.86 mm ~ 1.04 mm)	5050865-5 Digi-key

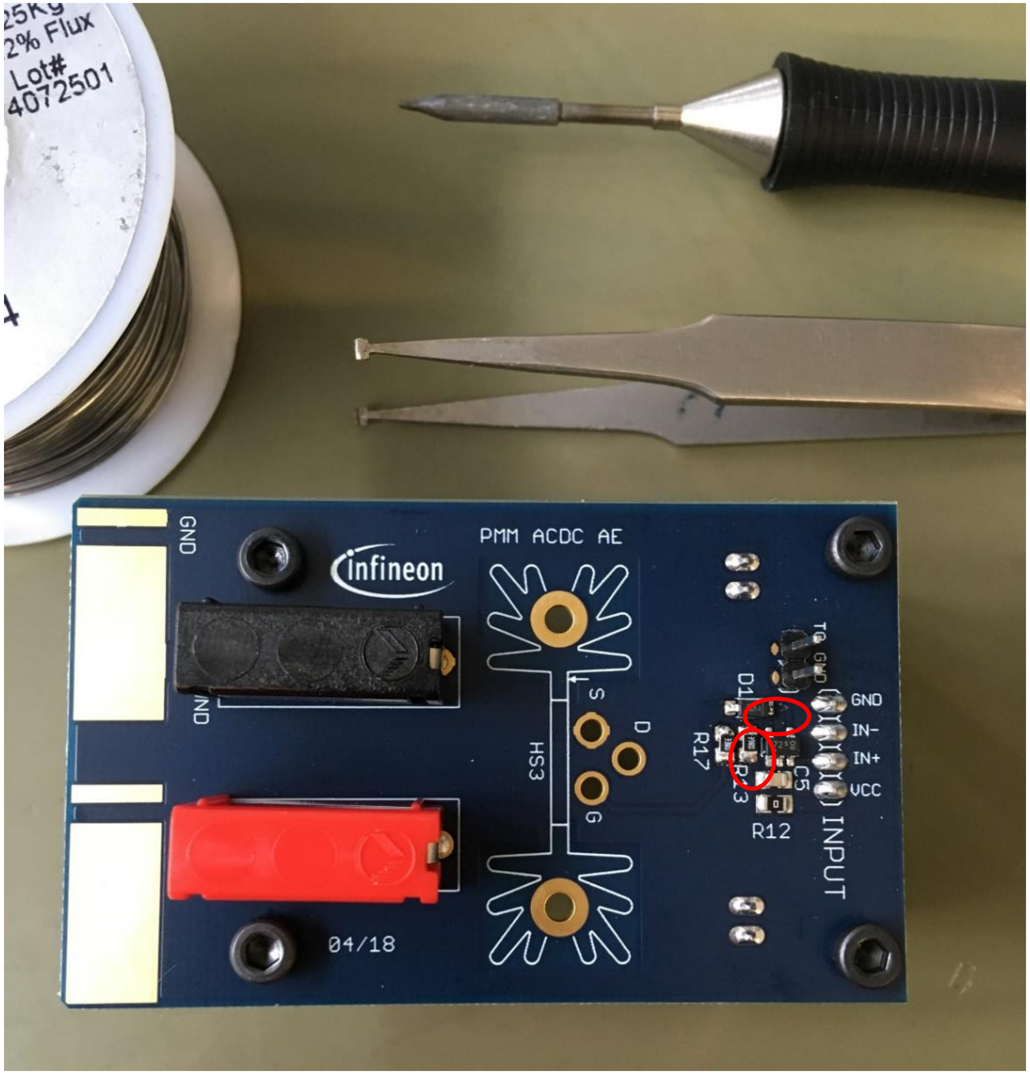
Step 1: Distance bolts mounting



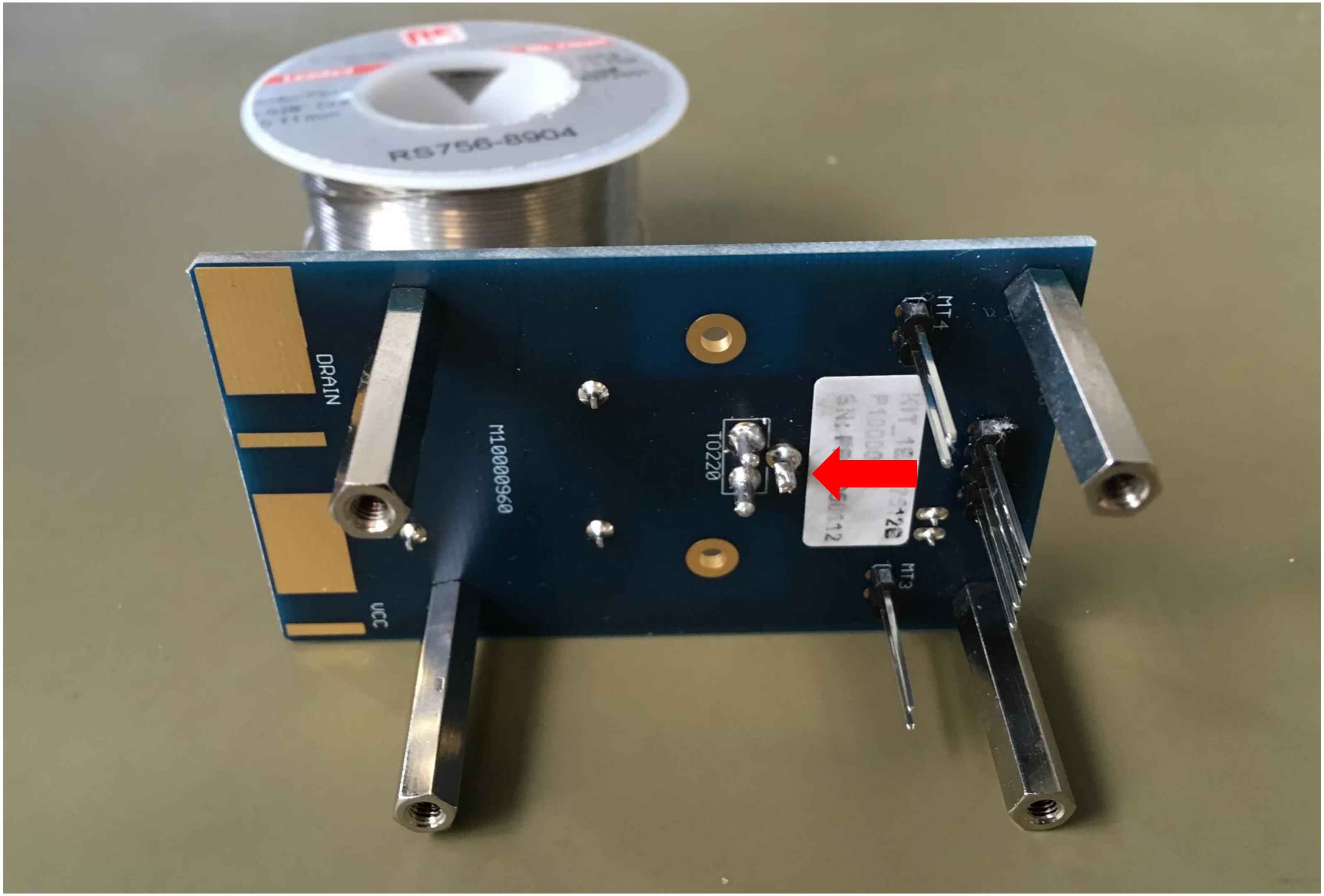
Step 2: Source resistor soldering



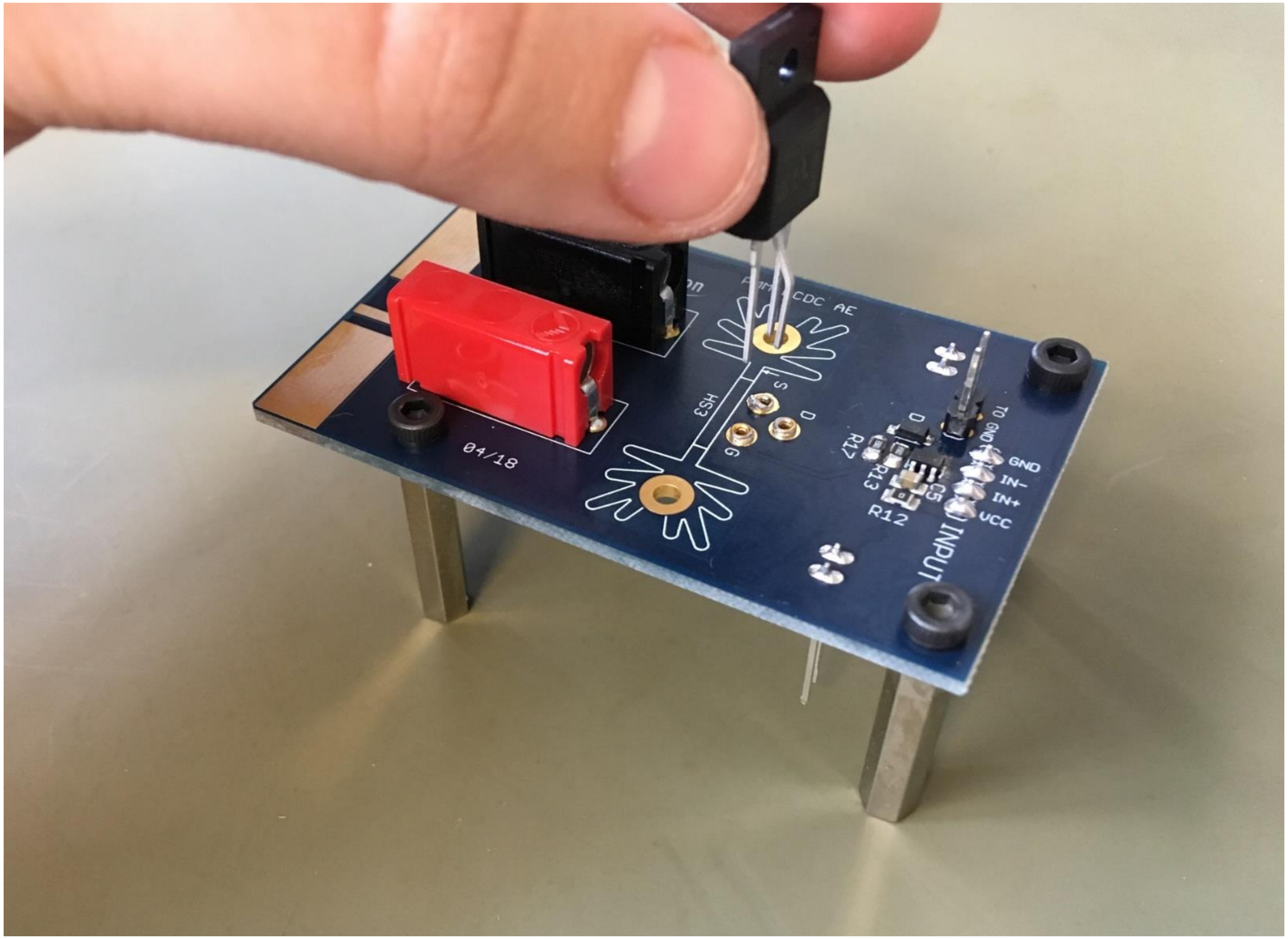
Step 3: Sink resistor and sink diode soldering



Step 4: TO-220 sockets soldering

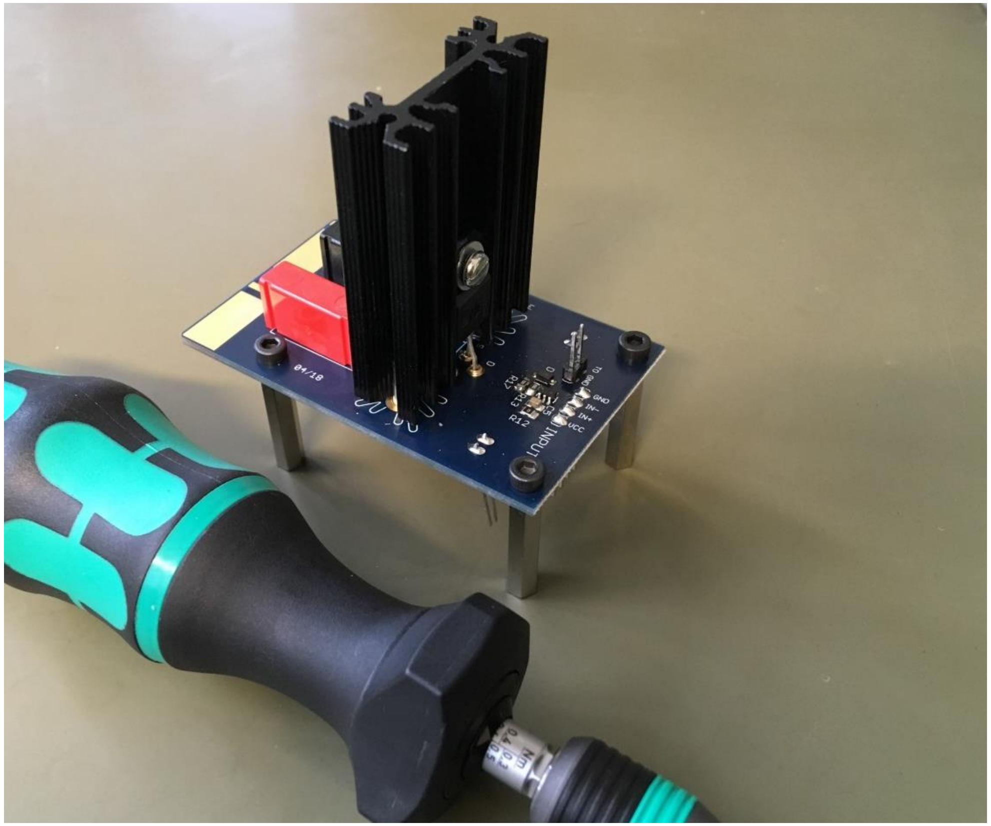


Step 5: MOSFETs placement into the sockets

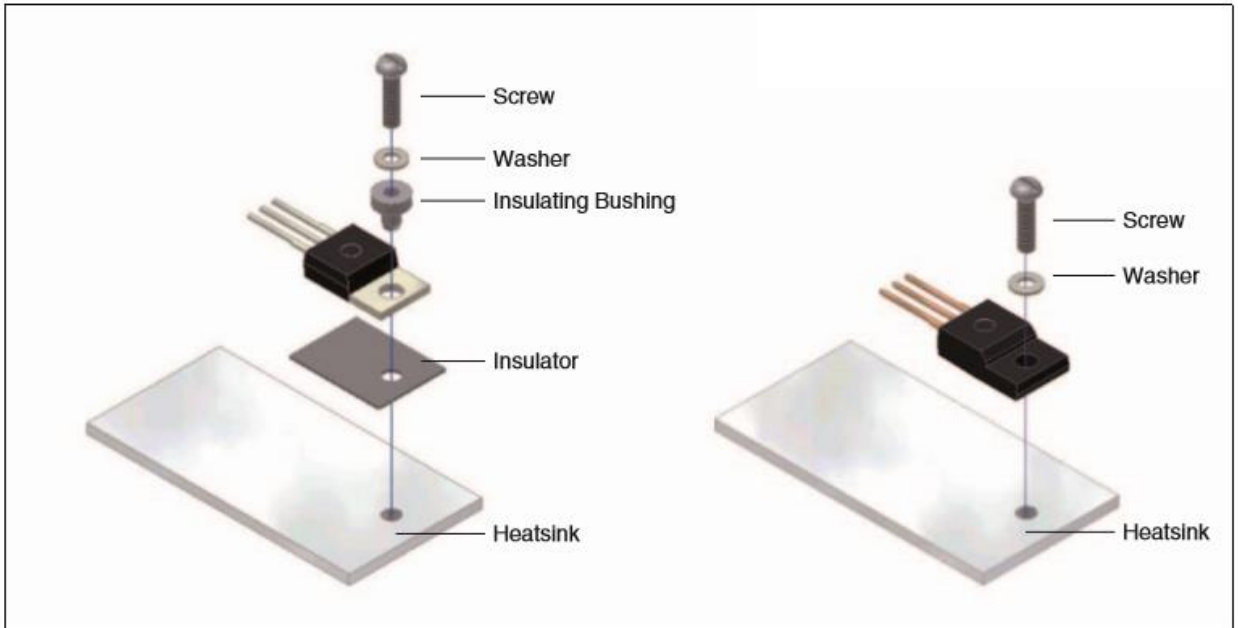


Step 6: Heatsink mounting (optional)

- Solder the heatsink if the board is used in high voltage scenarios
- In basic measurements it is not necessary
- See next slide for further information on how to properly mount the MOSFETs to the heatsink



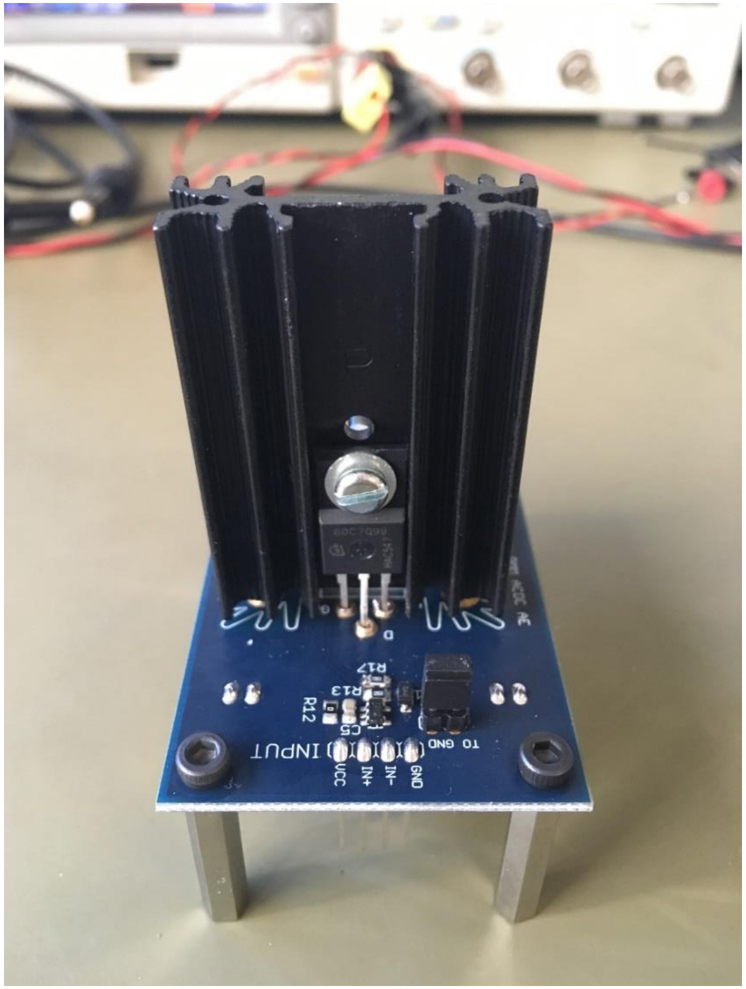
TO-220 MOSFET mounting to the heatsink



Package	Typ. Torque [Nm]	Max. Torque [Nm]	Comment
PG-TO220	0.6	0.7	Screw M3
PG-TO220 FullPAK	0.5	0.7	Screw M2.5

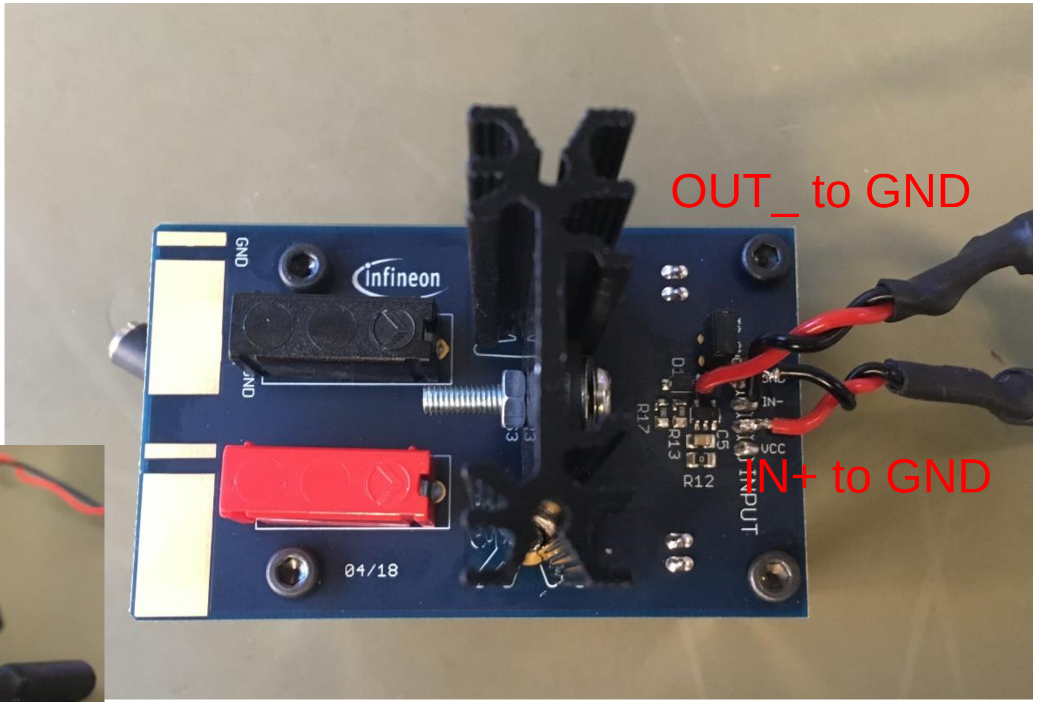
- Recommendations for assembly of Infineon TO packages: https://www.infineon.com/dgdl/Infineon-Package_recommendations_for_assembly_of_Infineon_TO_packages-AN-v01_00-EN.pdf?fileId=db3a30431936bc4b011938532f885a38

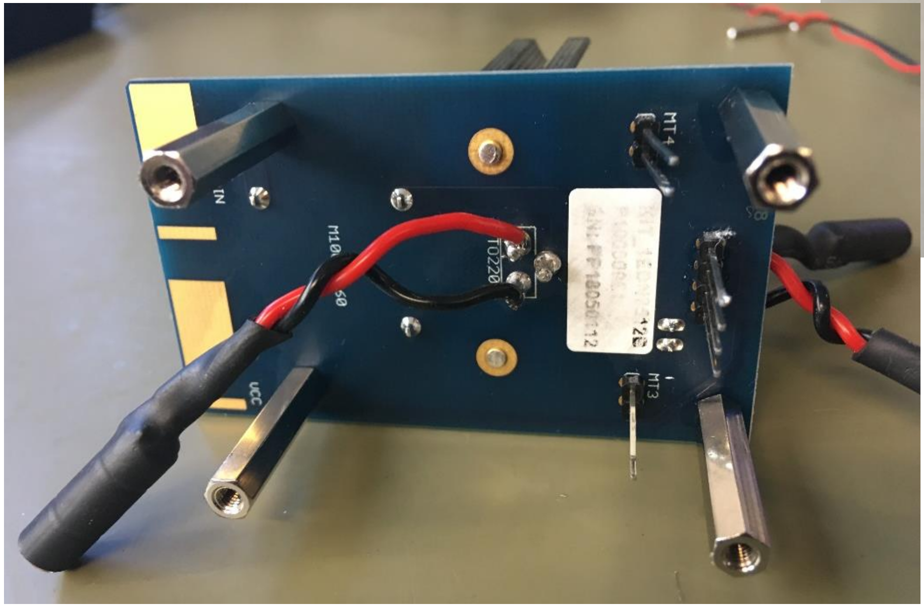
Step 7: IN- jumper connection



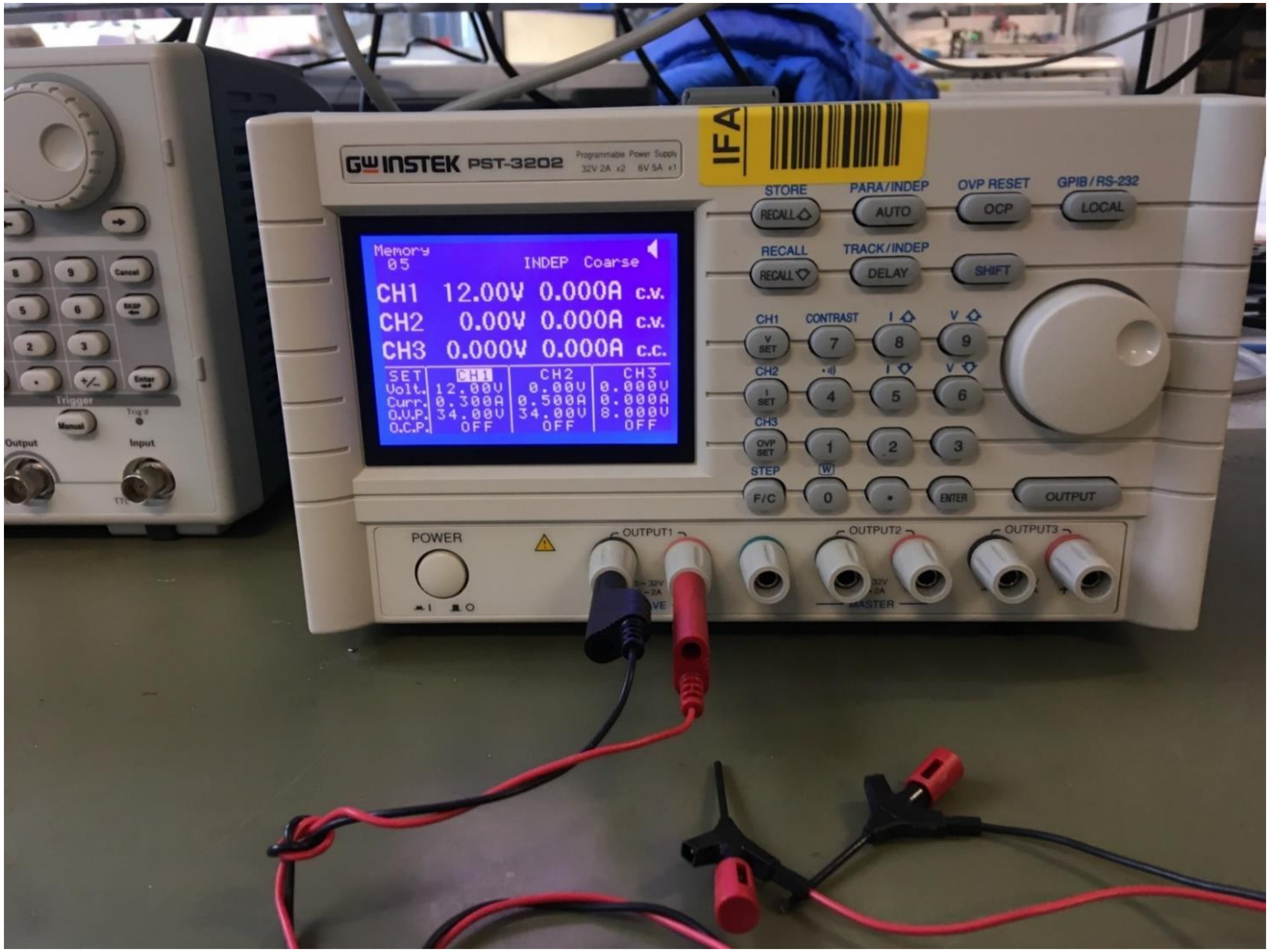
- In non-inverting operating mode, short IN- to GND with a jumper

Step 8: BNC connectors soldering



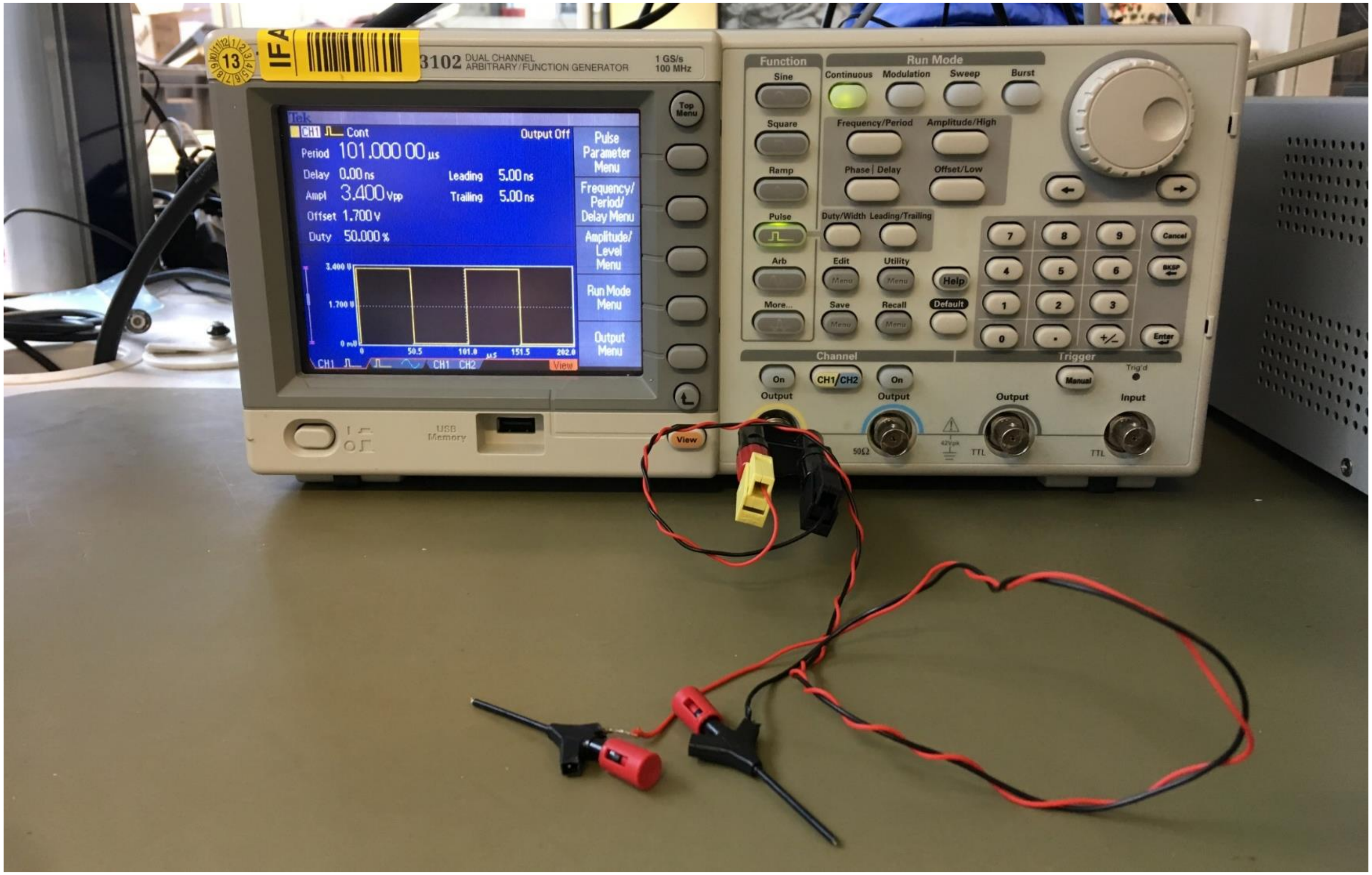


Instrumentation for driver supply generation



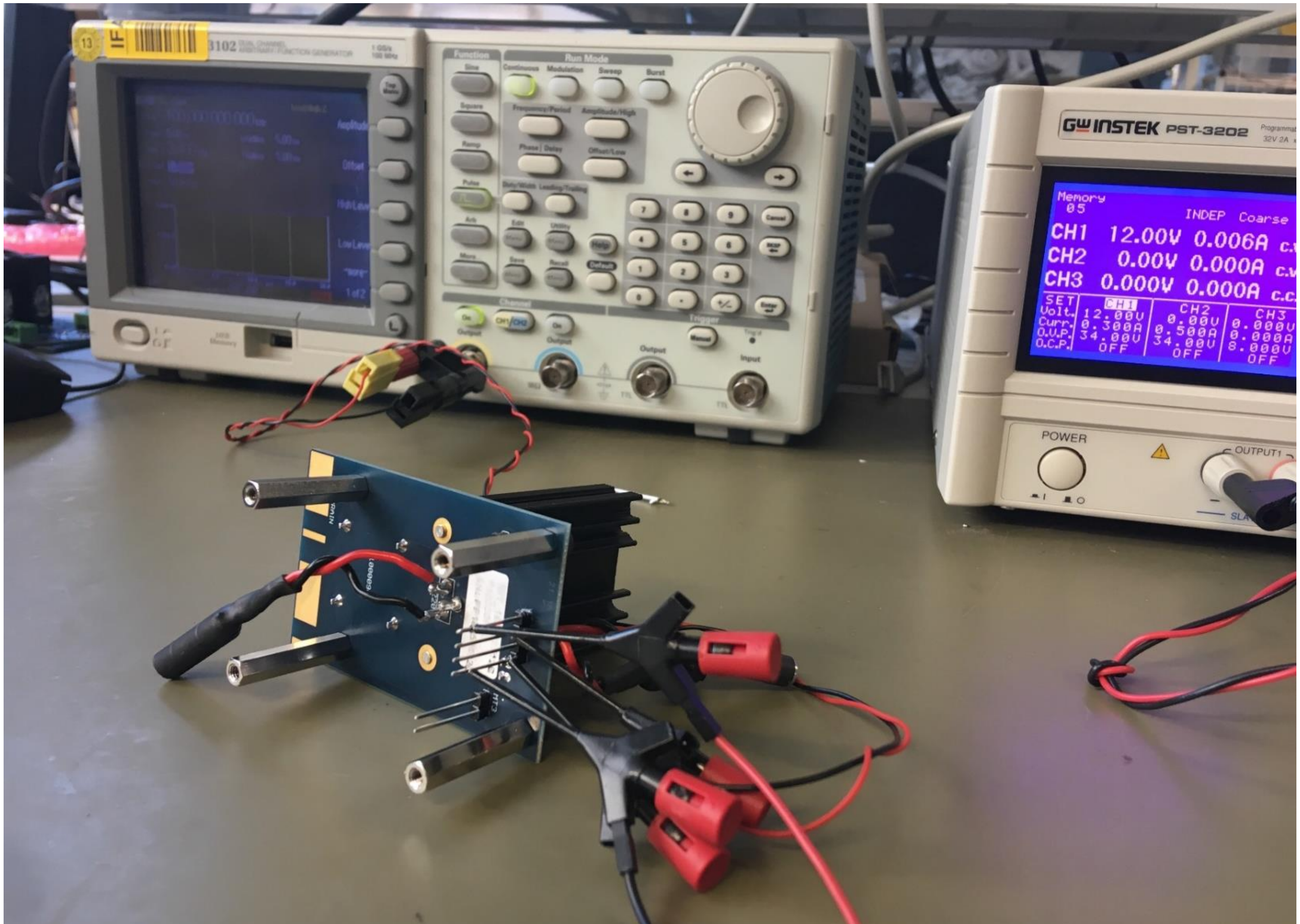
- V_{cc}=12 V for CoolMOS™ and 8 V for OptiMOS™
- Set the current limit to 0.3A

Instrumentation for PWM signals generation

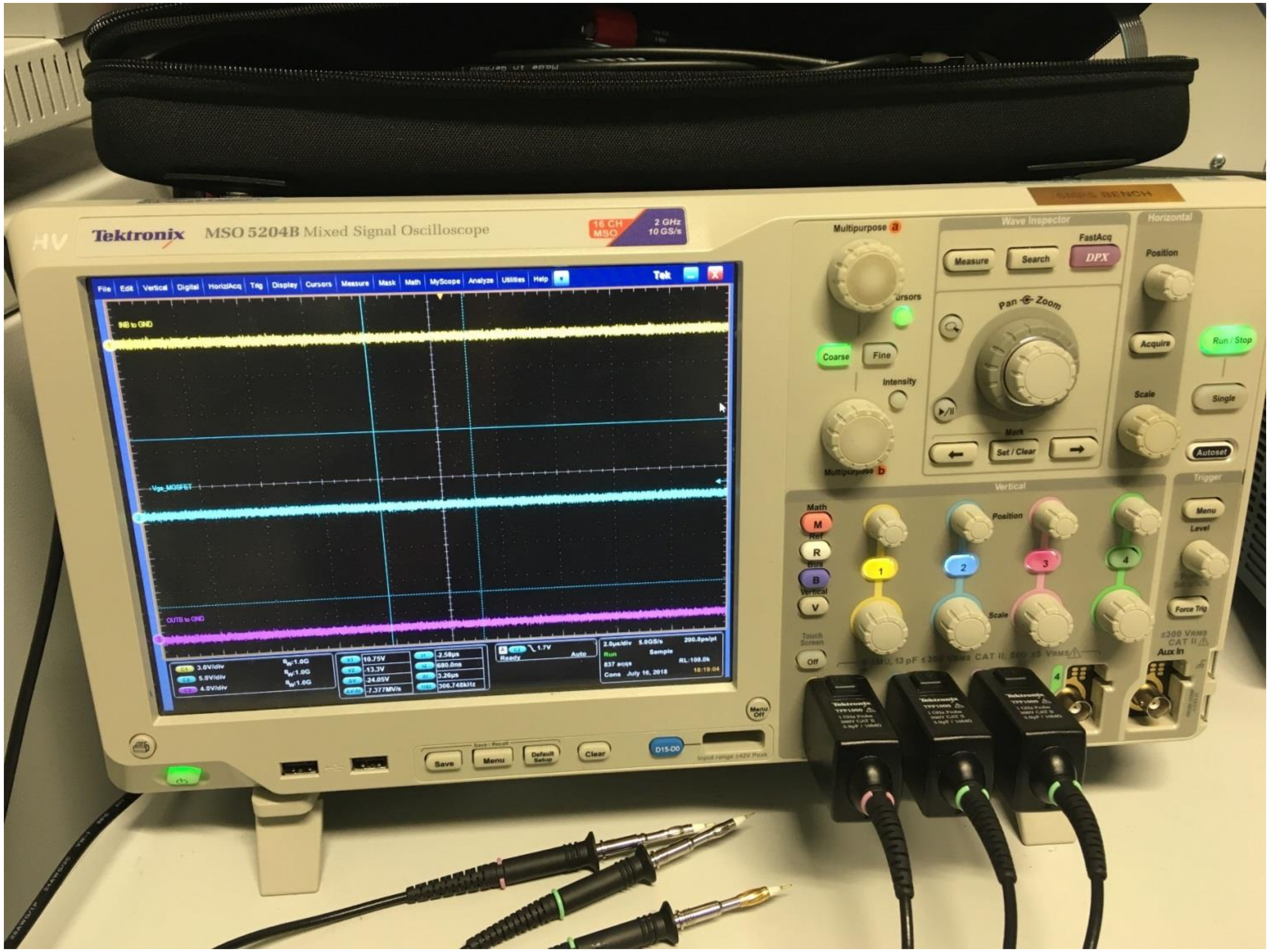


› Use a function generator or a microcontroller

Connections

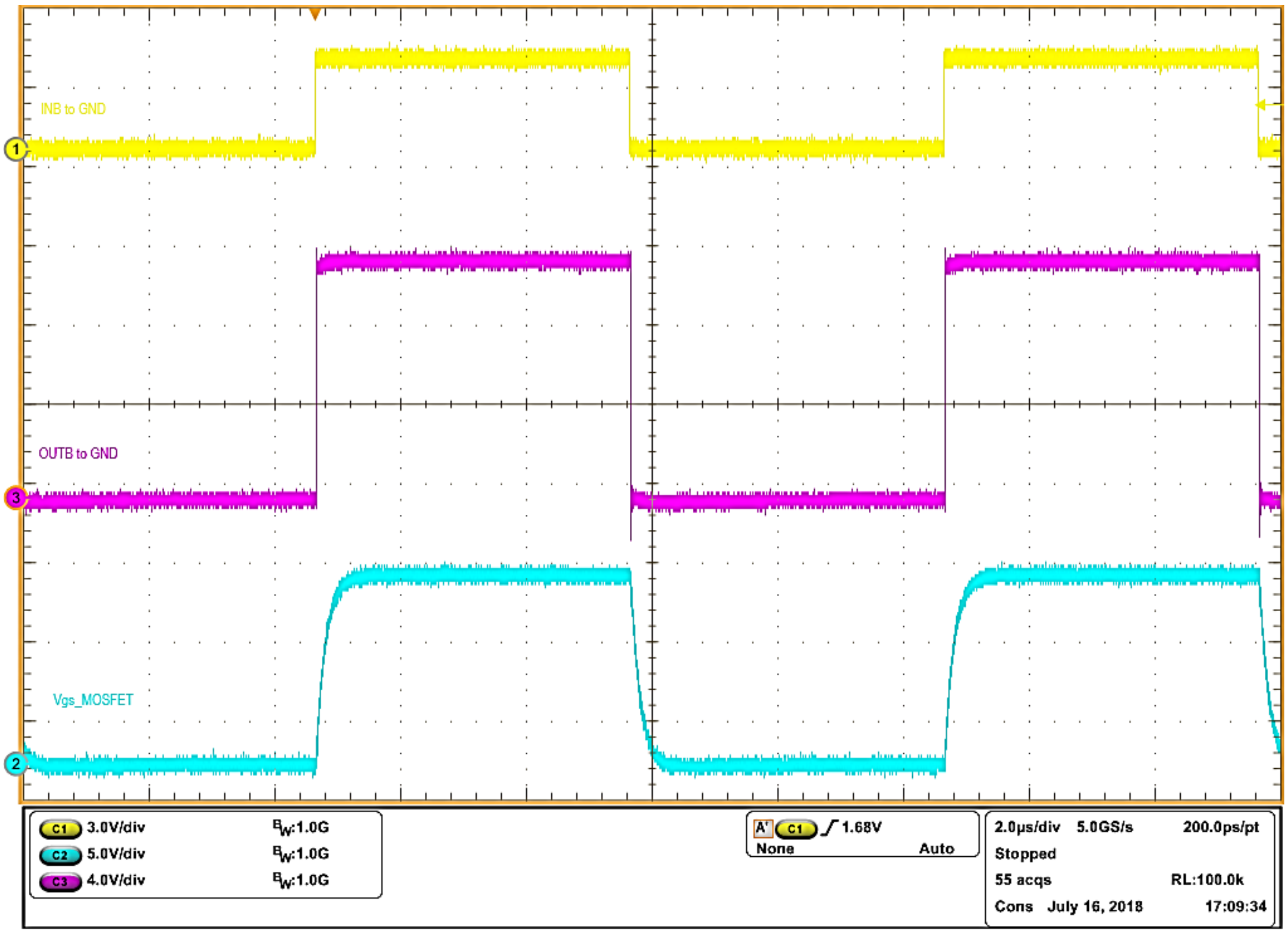


Instrumentation for signals evaluation



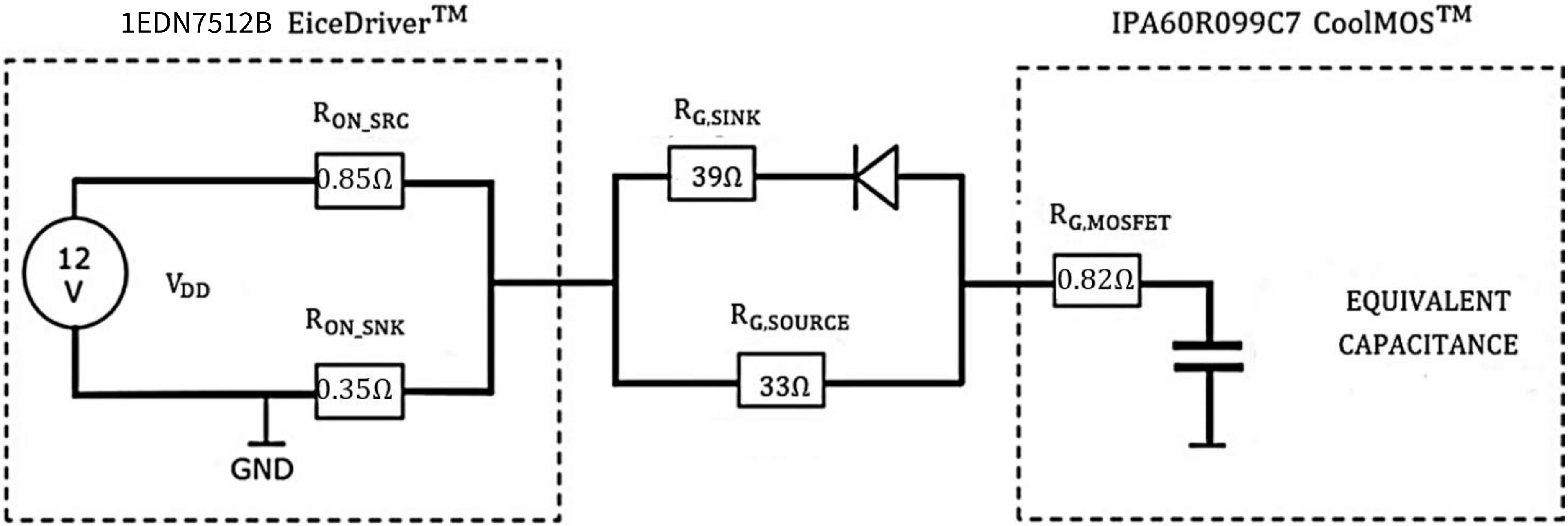
› Voltage probes used: Tetronix TPP1000 1 GHz, 3.9 pF

Oscilloscope waveforms



› Measurements done with $V_{DS} = 0\ V$ (drain and source shorted)

Equivalent model of the driving circuit



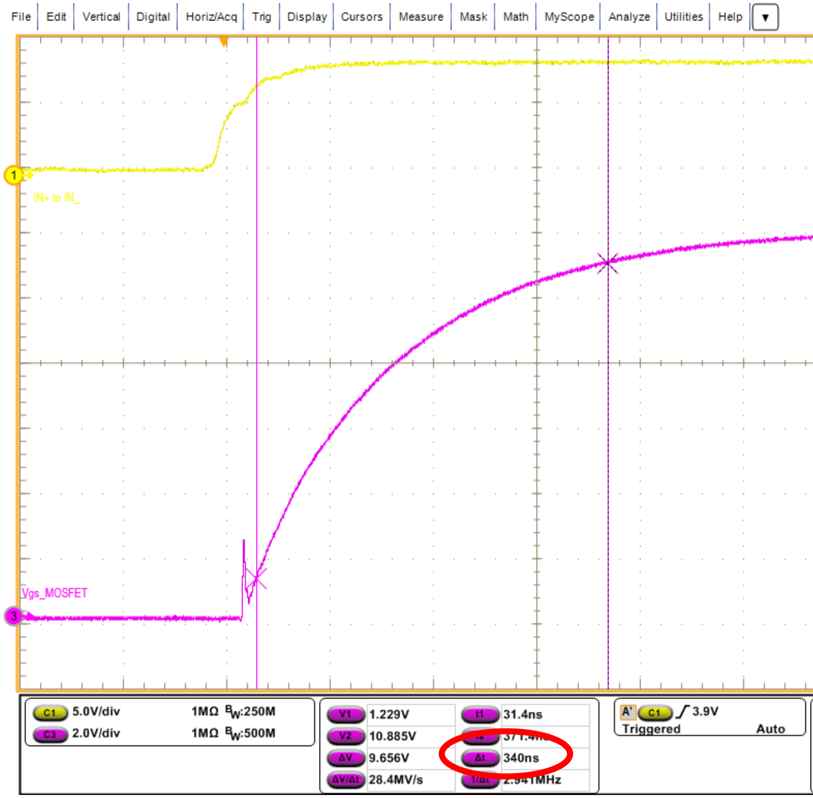
CLOAD calculation for IPA60R099C7

Gate to drain charge	Q_{gd}	-	14	-	nC	V_{DD}=400V, I_D=9.7A, V_{GS}=0 to 10V
Gate charge total	Q_g	-	42	-	nC	V_{DD}=400V, I_D=9.7A, V_{GS}=0 to 10V

$$Q_{LOAD} = Q_g - Q_{gd} = 28\,nC \rightarrow C_{LOAD} = \frac{Q_{LOAD}}{V_{GS}} = 2.8\,nF \quad for\ V_{GS} = 10\,V \longrightarrow$$

$$C_{LOAD} \approx 2.8\,nF \quad for\ V_{GS} = 12\,V$$

Rise/fall times



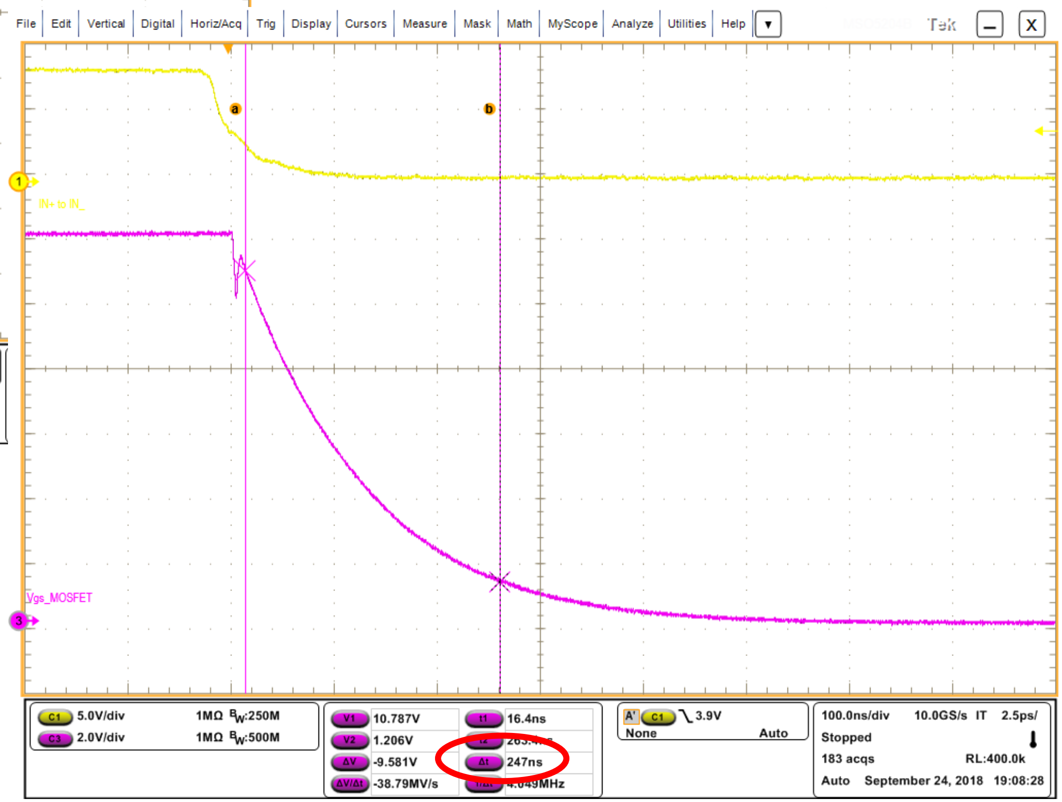
$R_{G,SOURCE} = 39\ \Omega$

$R_{G,SINK} = 33\ \Omega$

$MOSFET = IPA60R099C7$

$R_{G,MOSFET} = 0.82\ \Omega$

$C_{LOAD} \approx 2.8\ nF$



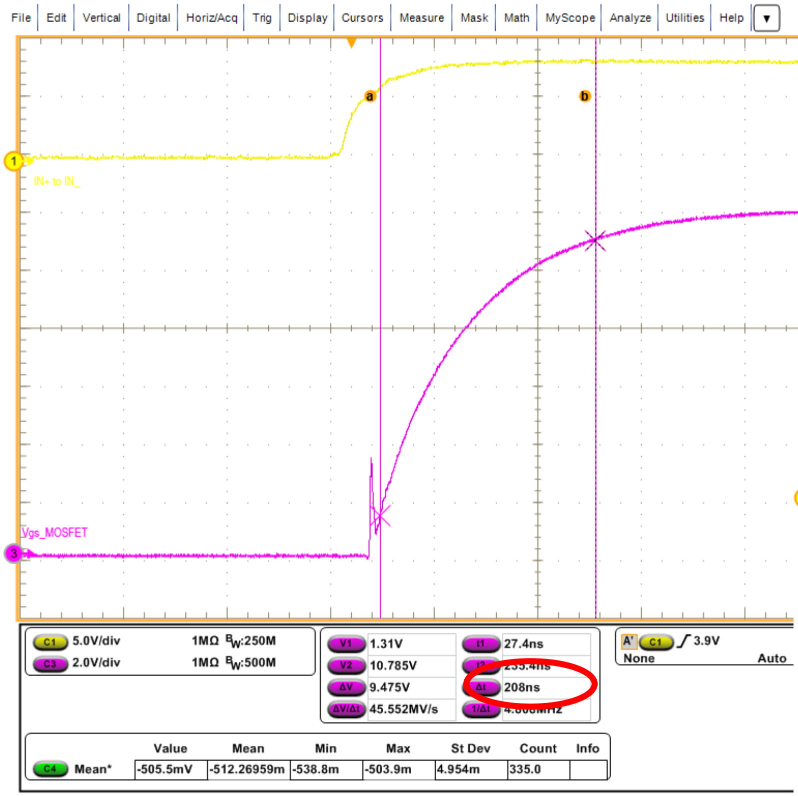
Gate resistors replacement

$$R_{\mathrm{G,SOURCE}} = 39\ \Omega \quad \rightarrow \quad 24\ \Omega$$

$$R_{\mathrm{G,SINK}} = 33\ \Omega \quad \rightarrow \quad 20\ \Omega$$

MOSFET = IPA60R099C7

Rise/fall times: New set of gate resistances



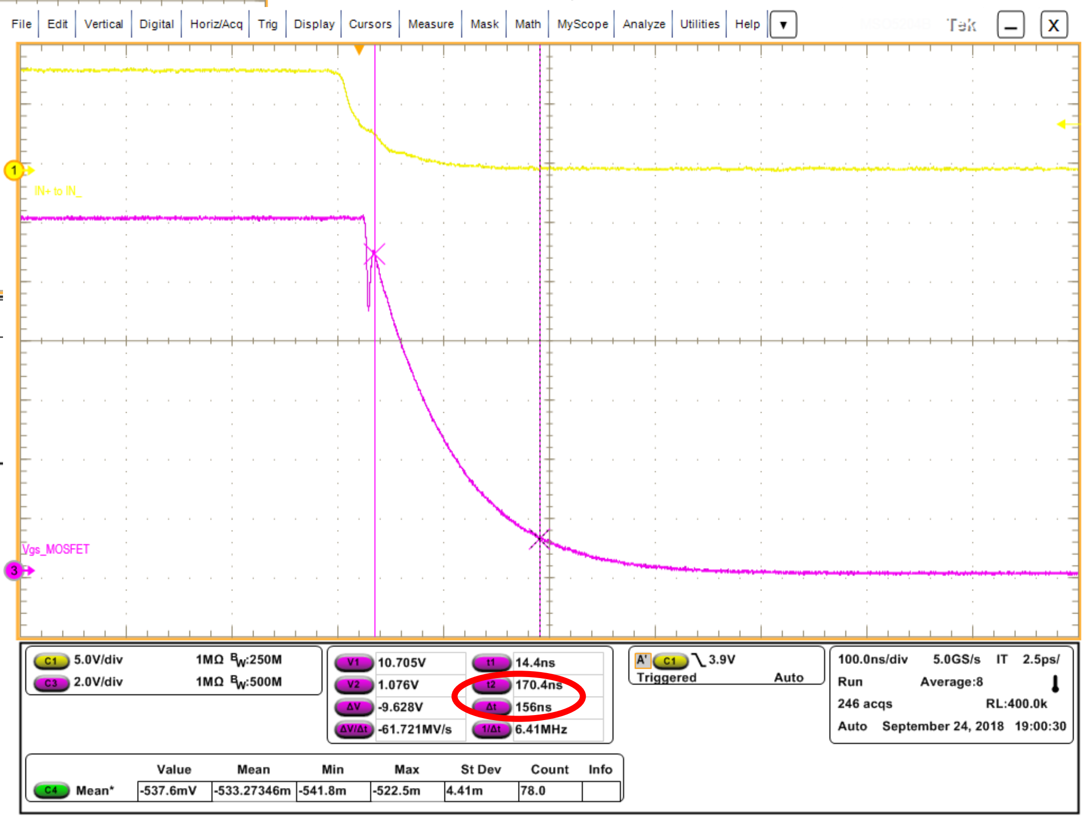
$R_{G,SOURCE} = 24\ \Omega$

$R_{G,SINK} = 20\ \Omega$

MOSFET = IPA60R099C7

$R_{G,MOSFET} = 0.82\ \Omega$

$C_{LOAD} \approx 2.8\ nF$



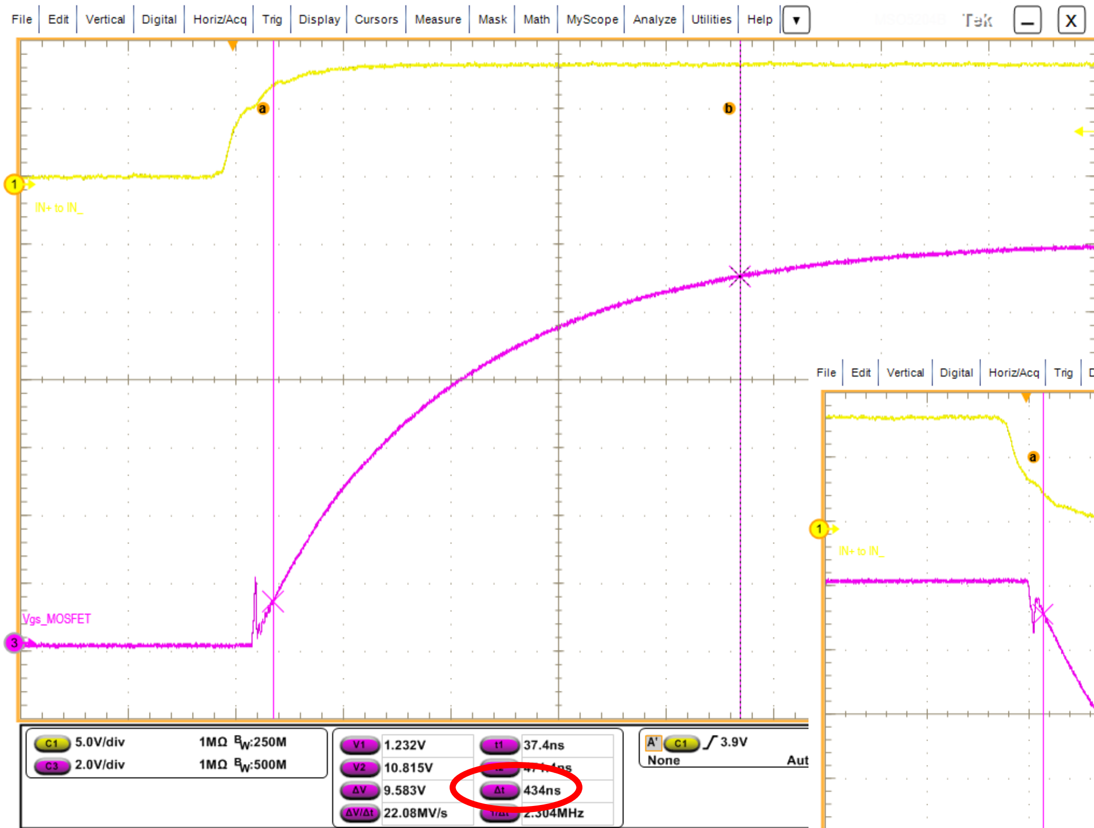
Gate resistors replacement

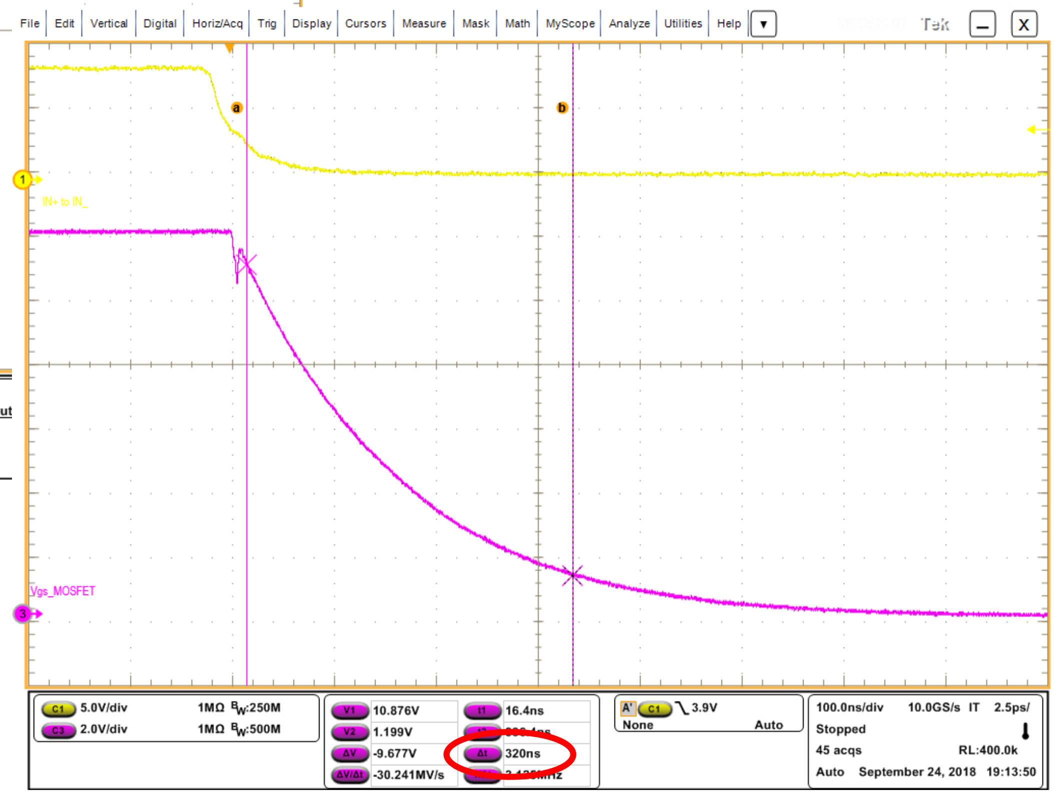
$$R_{G,SOURCE} = 24\ \Omega \quad \rightarrow \quad 51\ \Omega$$

$$R_{G,SINK} = 20\ \Omega \quad \rightarrow \quad 43\ \Omega$$

MOSFET = IPA60R099C7

Rise/fall times: New set of gate resistances





$R_{G,SOURCE} = 51\ \Omega$

$R_{G,SINK} = 43\ \Omega$

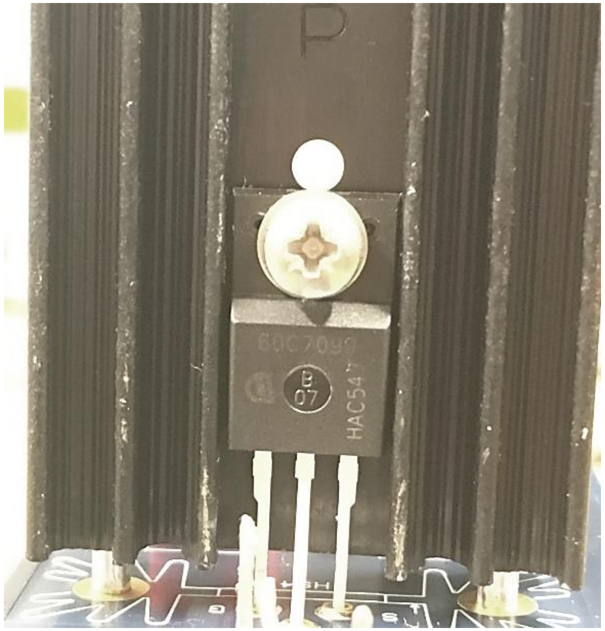
MOSFET = IPA60R099C7

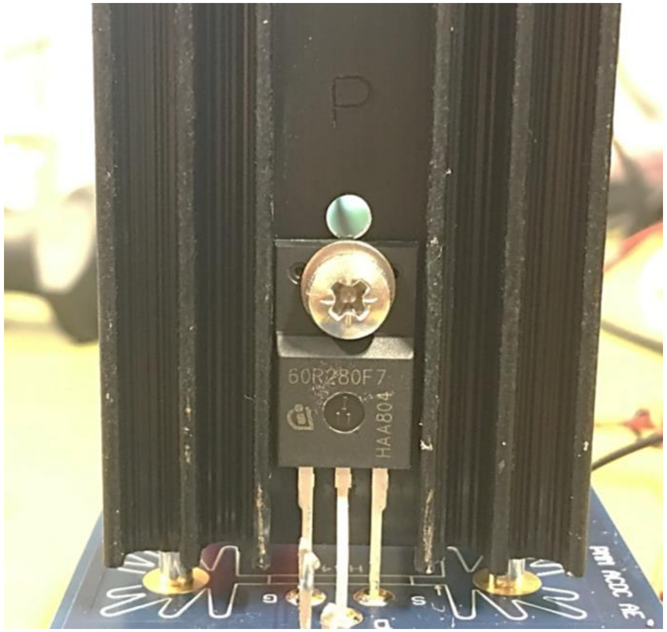
$R_{G,MOSFET} = 0.82\ \Omega$

$C_{LOAD} \approx 2.8\ nF$

MOSFET Replacement

IPA60R099C7 → IPA60R280CFD7

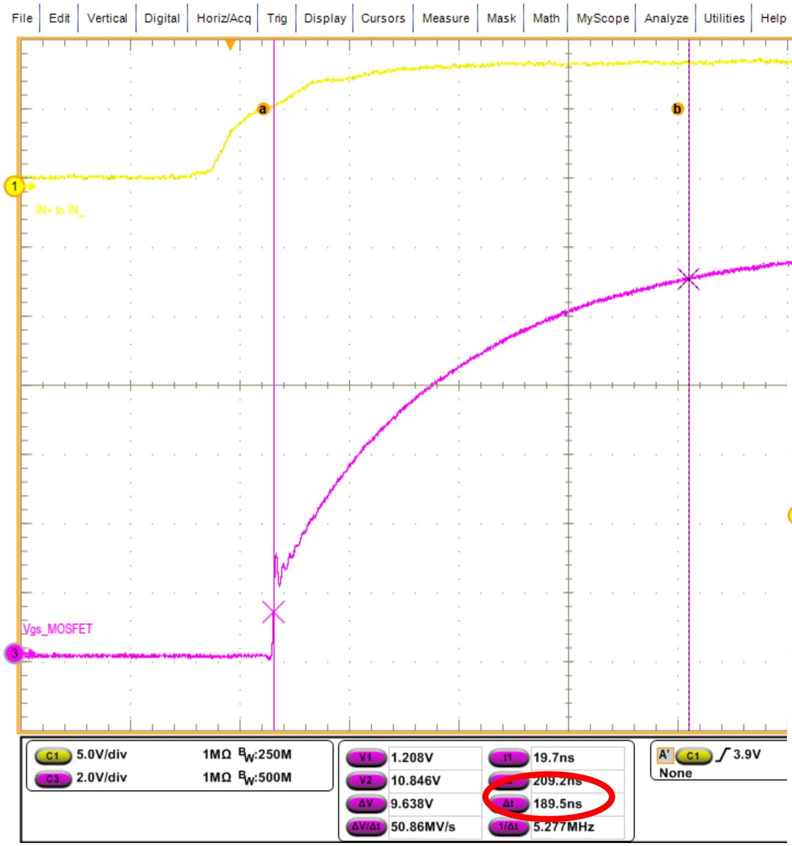




Gate to drain charge	Q_{gd}	-	5	-	nC	V_{DD}=400V, I_D=5.0A, V_{GS}=0 to 10V
Gate charge total	Q_g	-	18	-	nC	V_{DD}=400V, I_D=5.0A, V_{GS}=0 to 10V

$$C_{LOAD} \approx \frac{13\ nC}{10\ V} = 1.3\ nF \quad for\ V_{GS} = 12\ V$$

Rise/fall times: New MOSFET



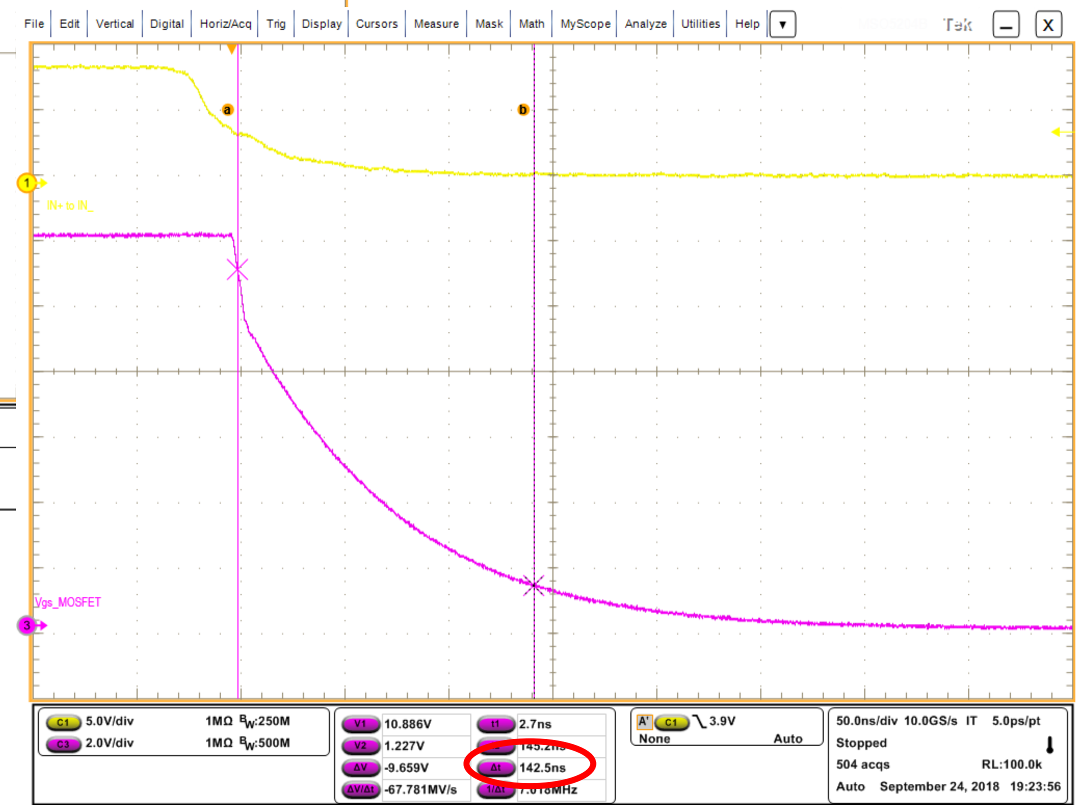
$R_{G,SOURCE} = 51\ \Omega$

$R_{G,SINK} = 43\ \Omega$

MOSFET = IPA60R280CFD7

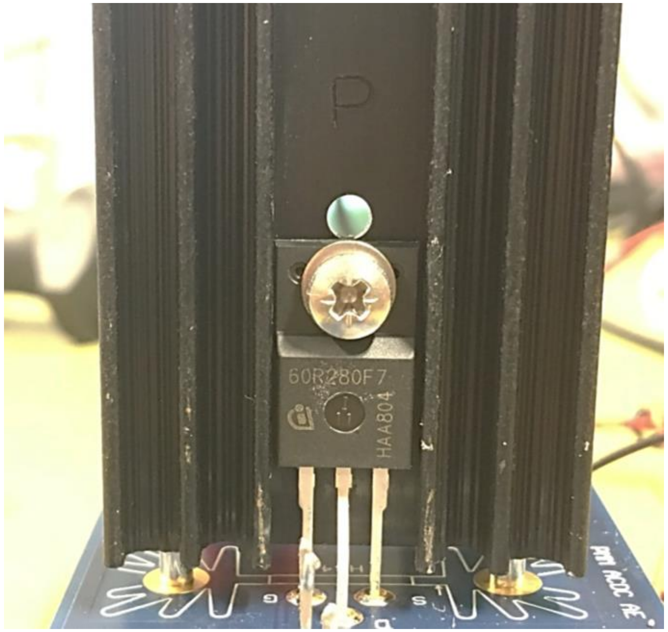
$R_{G,MOSFET} = 11\ \Omega$

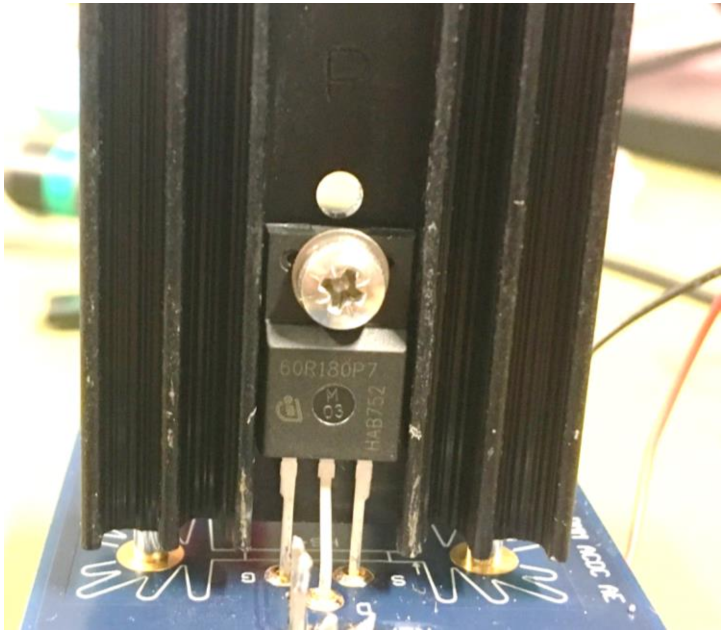
$C_{LOAD} \approx 1.3\ nF$



MOSFET replacement

IPA60R280CFD7 → IPA60R180P7

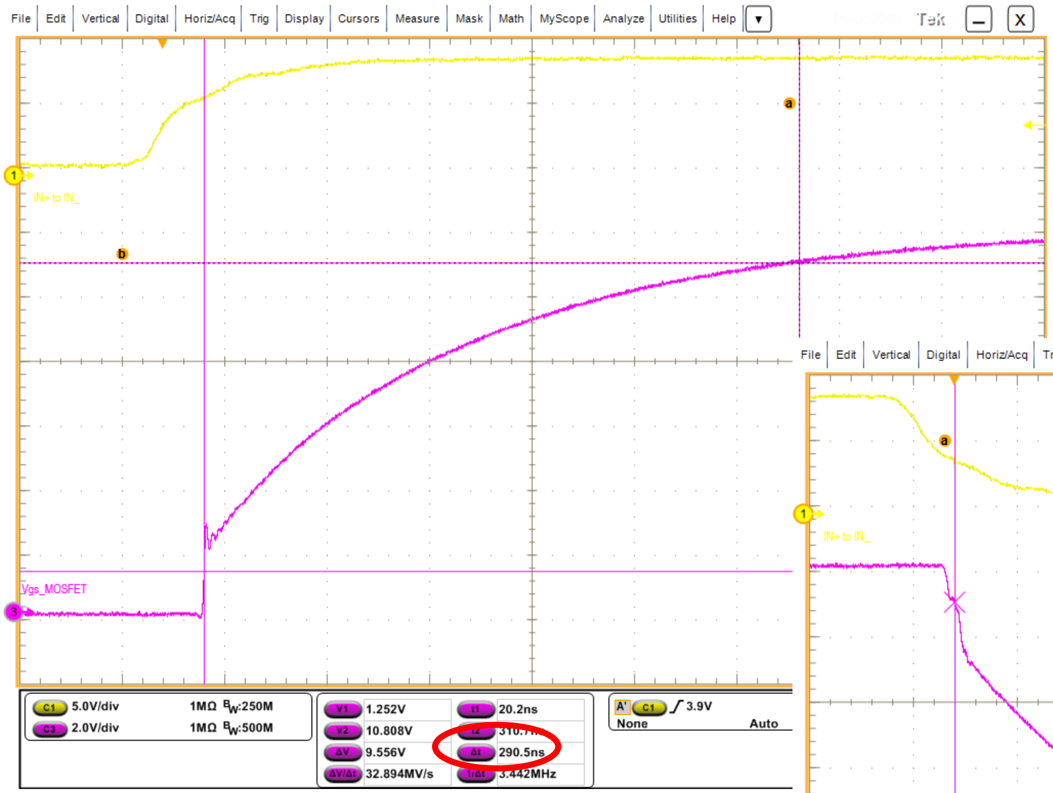




Gate to drain charge	Q_{gd}	-	8	-	nC	V_{DD}=400V, I_D=5.6A, V_{GS}=0 to 10V
Gate charge total	Q_g	-	25	-	nC	V_{DD}=400V, I_D=5.6A, V_{GS}=0 to 10V

$$C_{LOAD} \approx \frac{19\ nC}{10\ V} = 1.9\ nF\ \ for\ V_{GS} = 12\ V$$

Rise/fall times: New MOSFET



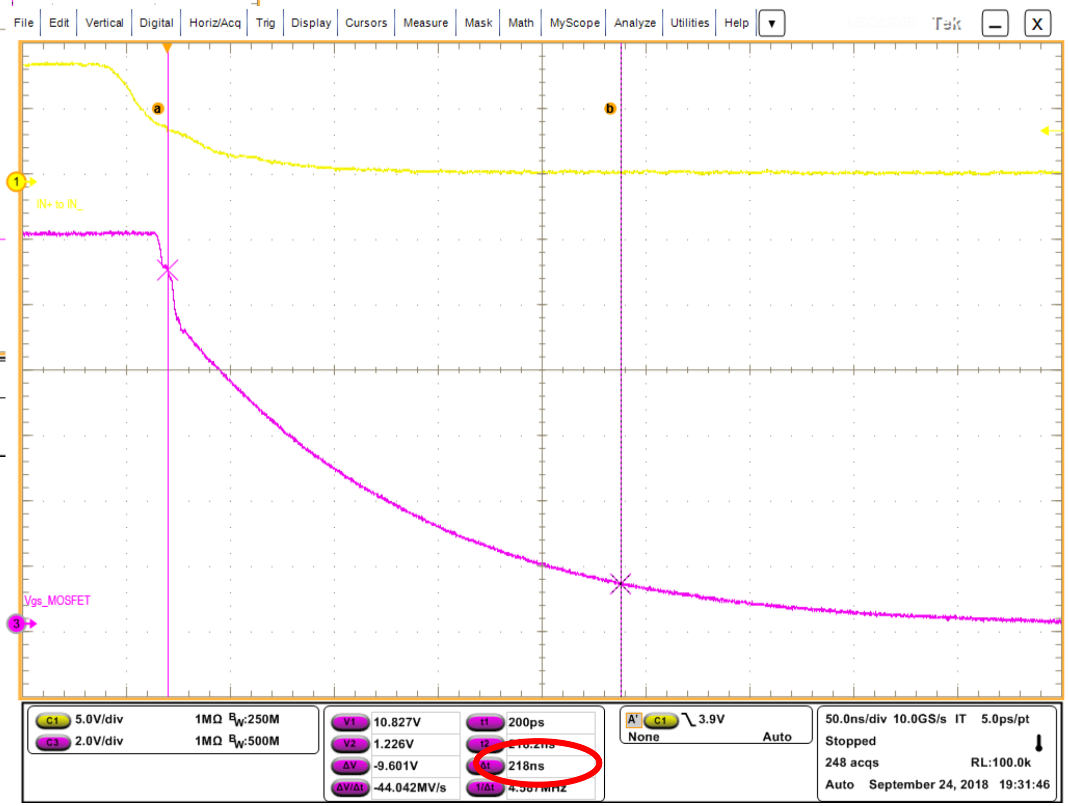
$R_{G,SOURCE} = 51\ \Omega$

$R_{G,SINK} = 43\ \Omega$

$\mathrm{MOSFET} = \mathrm{IPA60R180P7}$

$R_{G,MOSFET} = 11\ \Omega$

$C_{LOAD} \approx 1.9\ \mathrm{nF}$



Additional notes

- Note that the MOSFET is not turned-on or -off, you are only charging/discharging the gate-to-source capacitance
- Changing the gate resistors and the MOSFETs, you are changing the load for the driver
- If you want to turn-on or turn-off the MOSFET, you must integrate the board in a proper circuit
- You can not apply directly the voltage (e.g 400 V) across the MOSFET through the banana connectors on the board
- You must limit the input current from the DC source generator → add an inductance
- You must create a freewheeling path for the current when MOSFET is off

Example: boost converter, simple MOSFET in clamped inductive mode

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IMPORTANT NOTICE

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